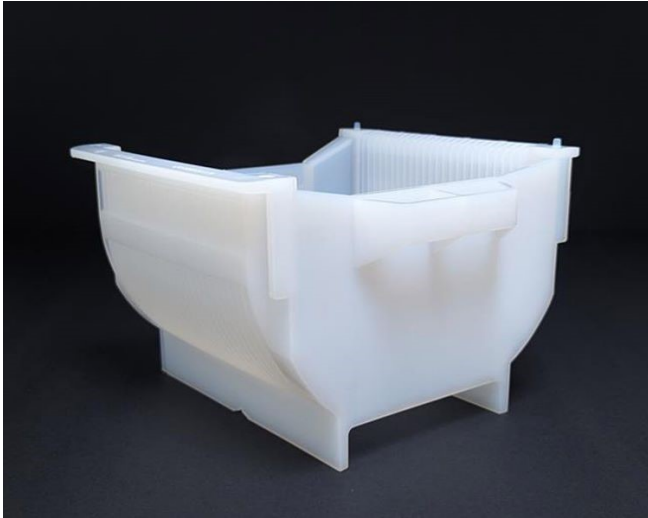




Process Carrier

eWB0385-eM-39-NAT



Description: 200mm Low-Profile Wafer Carrier, PFA

Order Code: eWB0385-eM-39-NAT

Manufacturer: ePAK

Packaging: 1/pk, 2/cs

MPN: ePB-8/200-25-R.10-eM-39-NAT

Item Notes

For wet processing of 200mm wafers

- 25 wafer capacity
- Overall size: 203mm x 234mm x 155mm
- D1 (bottom to first wafer): 25.4mm
- Pocket spacing: 6.4mm
- Pocket flat: 1.7mm
- Boxes: eWB0094, eWB0100
- Similar to Entegris A192-81M-0215

Material Notes

ePAK eM-39 is a PFA (perfluoroalkoxy) material

- PFA key properties:
- Translucent/milky white (can be colored)
- Low dielectric constant (insulating)
- Very low coefficient of friction
- UV resistant (does not age)
- Not hygroscopic (water absorption <0.03%)
- Continuous use temperature limit: 180°C
- Melting temperature: 300°C
- Specific gravity: 2.15 g/cm³
- Chemical resistance: Excellent



Exclusive US Distributor of ePAK Products

+1 719.445.8822
redstonetechnical.com

info@redstonetechnical.com